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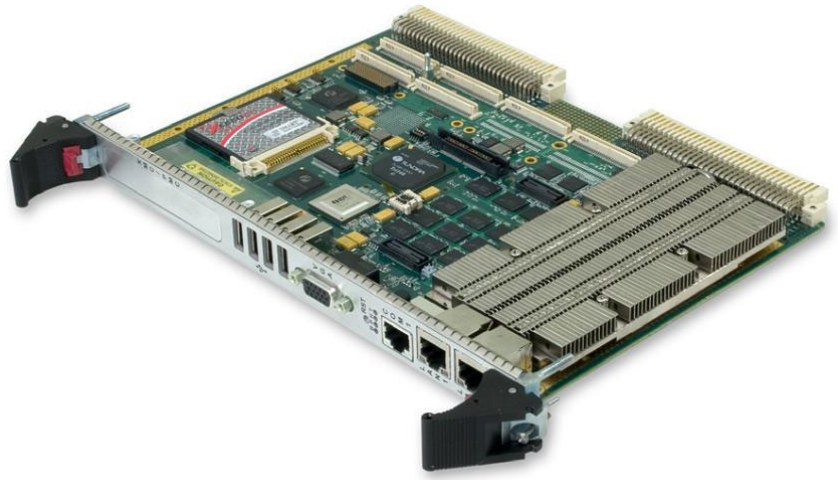
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XVB602

Intel Core i7 Based VME Single Board Computer

Features

- Intel® Core i7 Processor up to 2.53 GHz
 - Integrated two channel DDR3-1067 memory controller with ECC
 - Up to 4 MBytes shared cache
- Up to 8 GBytes soldered DDR3 SDRAM with ECC
- Mobile Intel QM57 Express chipset
- Up to 16 GBytes CompactFlash
- Dual on-board Expansion Sites:
 - One PCI-X PMC/ x4 PCIe XMC expansion site
 - One PCI-X PMC expansion site
- x8 PCIe board-to-board connector (supports EXP237 Carrier/IO expansion board)
- Front IO
 - 2x Gigabit Ethernet
 - 4x USB 2.0 ports
 - 1x VGA
 - 1x COM port
 - NOTE: Some Front IO is only available with a single PMC
- Rear IO
 - 4x SATA ports
 - 1x DVI-I
 - 4x USB 2.0 ports
 - 1x COM port
 - 2x PMC IO
 - 8x GPIO
- Operating System Support for Windows®, VxWorks®, and Linux®
- Single slot 6U VME64 form factor
- Compliant to IEEE STD 1101.2-1992 and ANSI/VITA 20-2001, VITA 30.1

The XVB602 Single Board Computer (SBC) from GE Intelligent Platforms features the highly integrated Core i7 processor platform from Intel. Core i7 offers integrated graphics and memory controller plus dual core processing up to 2.53 GHz.

Coupled with the Mobile Intel QM57 Express Chipset this provides an unmatched level of I/O bandwidth for both on-board and off-board functions.

Features of the Core i7 processor:

- Intel Intelligent Power Technology allows processors to operate at optimal frequency and power.
- Intelligent performance on-demand with Intel Turbo Boost Technology
- Multi-level shared cache improves performance and efficiency by reducing latency to frequently used data
- Hyper-Thread Technology – 2 threads per core
- Streaming SIMD extensions 4.1/4.2

The XVB602 offers two on-board mezzanine expansion sites for enhanced system flexibility, one of which is PMC/XMC capable and one of which is PMC only.

The XVB602 provides further customer defined I/O capabilities with the board-to-board connector for the EXP237 XMC/PMC carrier/IO expansion board, which offers customers three additional PCI-X XMC/PMC expansion sites to utilize.

Specifications

Processor

- Intel Core i7 32nm Processor:
 - ULV @ 1.06 GHz
 - SV @ 2.53 GHz
- 4 MByte shared cache on all processor options
- Integrated two channel DDR3-1067 memory controller with ECC

SDRAM

- Maximum memory configuration of up to 8 GBytes DDR3 SDRAM soldered with ECC

Compact Flash

- CompactFlash up to 16 GB is supported through the conversion of a SATA port from the QM57 chipset to a PATA CF bus interface

UEFI (replaces BIOS)

- The XVB602 System UEFI includes all functions required by the processor core and chipset
- Also supports expansion ROM code for remote booting from either of the dual Ethernet ports

Ethernet

- Dual Gigabit Ethernet interface via two Intel 82574 Gigabit Ethernet controllers – routed to front panel

USB Ports

- Eight USB 2.0 ports: four to front panel I/O, and four to rear via P2
- Keyboard and Mouse (PS2) emulation via USB

VMEbus Backplane Interface

- 2eSST capable via TSi148 (ANSI/VITA 1.5-2003 offering bandwidths up to 320 MB/s)



XVB602 Intel Core i7 Based VME Single Board Computer

Specifications (continued)

Serial Ports

- Two 16550 compatible full duplex async serial ports
- COM1 routed to front panel RJ45 (RS232/422/485)
- COM2 routed to P2 (RS232/422/485) requires transceivers [to convert from TTL] on RTM
- Ports feature independent 16-byte FIFO supporting baud rates up to 115 Kbaud

PMC/XMC Expansion

- Site 1 is PMC (PCI-X up to 64 bit/133 MHz) and XMC (x4 PCIe Gen 2, 2.5 GT/s) capable
- Site 2 is PMC (PCI-X up to 64 bit/133 MHz) capable
- Up to 3 additional mezzanine sites can be added via the EXP237 (see EXP237 data sheet.)

Video

- Provided via the integrated Intel Graphics Controller
- VGA on front panel with DVI-I routed to P2 (for use with ACC-0603 or ACC-0627)
- Any 2 ports can be used for dual display operation

SATA

- Two Gen 2 (3 GB/s) SATA ports to rear IO (P2)
- Two optional Gen 2 (3 GB/s)/e-SATA ports to rear IO (P0) available when P0 option fitted

GPIO

- 8 GPIO pins available when P0 option fitted - software configurable

On-board hard drive

- 2.5" SATA hard drive or Flash disk can be optionally ordered (precludes use of PMC/XMC site 2)

Front Panel Options

- VME Standard
- 1101.10 front panel

Power Requirements

- +5V (+5/-2.5 percent); Core i7 @ 1.06 GHz: 5A (typical) to 8A (maximum); Core i7 @ 2.53 GHz: 8A (typical) to 12A (maximum)
- Plus ±12V if required by mounted PMC module

Watchdog/Timers/RTC/Temp sensors

- Two 16-bit timers and two 32-bit timers - software programmable and capable of generating PCI bus interrupts
- RTC 146818 compatible with Li
- CPU die and Chipset die, software readable

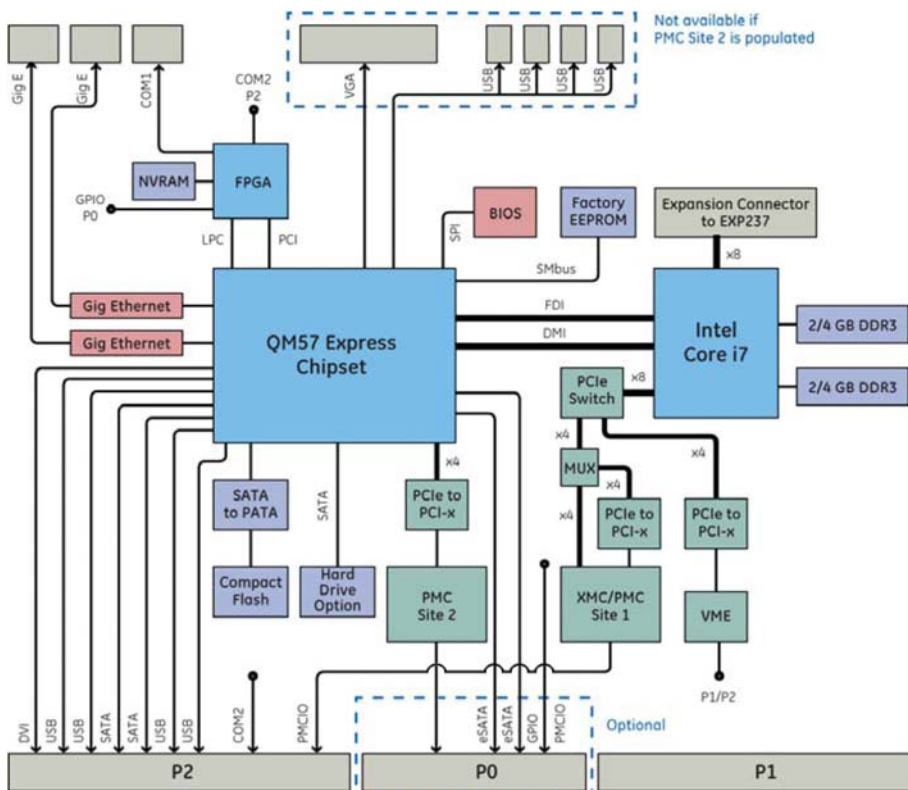
Transition Modules and Product Combinations

- ACC-0603
- ACC-0627
- EXP237 - Used via board-to-board connector (precludes use of on-board PMC2)

Software

- Support for Windows, Linux, VxWorks

Block Diagram



Environmental

	Level 1	Level B
Cooling Method	Convection	Convection
Conformal Coating	Optional	Standard
Operating Temp (for upper limit - please consult the manual)	0° to 55° C (300 ft/m)	-20° to 55° C (300 ft/m)
Random Vibration	0.002g ² /Hz*	0.002g ² /Hz*
Shock	20g**	20g**

*With a flat response to 1000 Hz, 6 dB/Oct roll-off from 1000 to 2000 Hz

**Peak sawtooth 11 ms duration

About GE Intelligent Platforms

GE Intelligent Platforms, a General Electric Company (NYSE: GE), is an experienced high-performance technology company and a global provider of hardware, software, services, and expertise in automation and embedded computing. We offer a unique foundation of agile, advanced and ultra-reliable technology that provides customers a sustainable advantage in the industries they serve, including energy, water, consumer packaged goods, government and defense, and telecommunications. GE Intelligent Platforms is a worldwide company headquartered in Charlottesville, VA and is part of GE Home and Business Solutions. For more information, visit defense.ge-ip.com.

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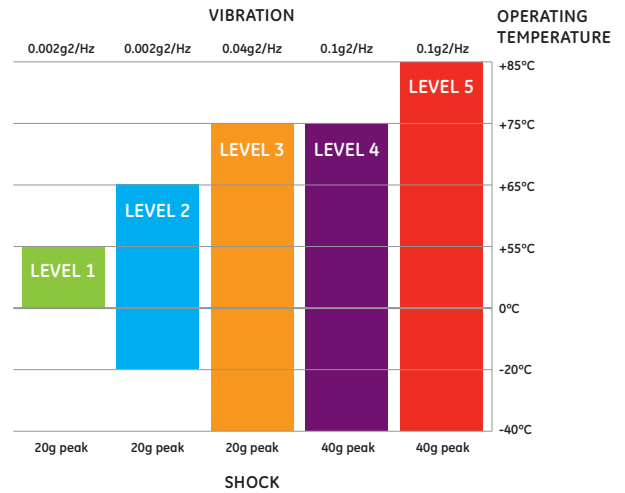
Standard Configuration

XVB602 - 1 3 1 0 0 0 1 0

Optional Configurations

XVB602	-	x	x	x	x	x	x	x	x	Description	Conditions
A		1 B								Level 1 Level B (-20 to +55, Conformally Coated)	
B			1 3							ULV 18W i7 (Dual Core) 1.06 GHz SV 35W i7 (Dual Core) 2.53 GHz	
C				1 2						4 GB DDR3 memory 8 GB DDR3 memory	
D					0 2 4					No Compact Flash 4 GB Compact Flash 16 GB Compact Flash	
E						0 1				1 PMC/XMC with Front I/O 2 Mezzanines, 1 PCI-X PMC/XMC and 1 PCI-X PMC with limited Front I/O	Not valid with F0, H1, H2, H3
F							0 1			No P0 P0	Not valid with E1
G								0 1		Standard VME Front Panel 1101.10 Front Panel	
H									0 1 2 3	Reserved 160 GB SATA HD 64 GB SSD (2.5") SATA Drive 250 GB SATA HD	Not valid with E1 Not valid with E1 Not valid with E1





Ruggedization

Full Environmental Compliance

Features

- Unique expertise/experience in ruggedization
- Products designed to be rugged
- Five levels of ruggedization available
- Compliant with all relevant standards, including:
 - ANSI/VITA 1.1-1997
 - ANSI/VITA 20-2001
 - ANSI/VITA 30.2-2002
 - PICMG 2.0 R3.0-1999
 - IEEE 1101.2-1992
- All build levels compatible, interoperable

GE Intelligent Platforms was among the very first companies to bring to market commercial off-the-shelf (COTS) products that were rugged by design – as opposed to commercial products that were ruggedized as an afterthought. Created to operate in the harshest environments, GE's products now reflect the company's unparalleled experience and expertise in ruggedization, with its unique combination of design evaluation and assembly and test practices through to advanced thermal management, mechanical engineering and hermetic control techniques.

GE ruggedizes its products by upgrading or screening parts for extended temperatures, adding mechanical stiffening bars, and/or changing substrate materials for thermal conduction. An integrated stiffening frame/thermal management assembly is used to optimize the mechanical dynamic and thermal performance. A variety of conformal coatings are available for humidity and static control.

The wide range of harsh military, aerospace and industrial environments for which GE products are designed sees them built in five

distinct ruggedization levels. Development systems are compatible and interoperable with deployed systems through the use of shared circuit design and software compatibility, allowing the most cost-effective option to be selected: each of the five levels differ only in the mechanical build standard, type of cooling and the quality of the electronic components used.

GE's five ruggedization levels offer increasing levels of environmental durability, enabling operational goals to be met at the lowest possible cost. Each ruggedization level has been carefully tailored to provide the optimal trade-off between cost, performance and reliability. Selection will depend on the type of cooling required – either forced air or by conduction – and the overall requirements for environmental performance.

Fully compliant with the ANSI/VITA 1-1994 VMEbus and IEEE Std 1101.2-1992 conduction-cooled specifications, GE products can be used with complete confidence in conjunction with both in-house designs and other vendor products that meet the same internationally recognized standards.



Ruggedization – Full Environmental Compliance

Summary Table

Ruggedization Level 1 Standard (Air-cooled)	
Operating Temperature	0 to +55°C with 300 linear ft./min. airflow
Storage Temperature	-50 to +100°C
Vibration	0.002g ² /Hz from 10 to 2000Hz random and 2g sinusoidal from 5 to 500Hz
Shock	20g peak sawtooth, 11mS duration
Humidity	Up to 95% RH

Notes: Commercial grade, for use in benign environments and software development applications.

Ruggedization Level 2 Extended Temperature (Air-cooled)	
Operating Temperature	-20 to +65°C with 300 linear ft./min. airflow
Storage Temperature	-50 to +100°C
Vibration	0.002g ² /Hz from 10 to 2000Hz random and 2g sinusoidal from 5 to 500Hz
Shock	20g peak sawtooth, 11mS duration
Humidity	Up to 95% RH with varying temperature, 10 cycles, 240 hours

Notes: Similar to standard, conformally-coated for added protection and temperature characterized.

Ruggedization Level 3 Rugged (Air-cooled)	
Operating Temperature	-40 to +75°C with 600 linear ft./min. airflow
Storage Temperature	-50 to +100°C
Vibration	0.04g ² /Hz 20 to 2000Hz, with a flat response to 1000Hz, 6dB/octave roll-off from 1000 to 2000Hz
Shock	20g peak saw tooth, 11mS duration
Humidity	Up to 95% RH with varying temperature, 10 cycles, 240 hours

Notes: Wide temperature, conformally-coated for added protection. Optional Environment Stress Screening (ESS).

Ruggedization Level 4 Rugged (Conduction-cooled)	
Operating Temperature	-40 to +75°C at the thermal interface
Storage Temperature	-50 to +100°C
Vibration	Random, 0.1g ² /Hz from 15 to 2000Hz per MIL-STD-810E Fig 514.4 - 8 for high performance aircraft. ~12g RMS
Shock	40g peak saw tooth, 11mS duration
Humidity	Up to 95% RH with varying temperature, 10 cycles, 240 hours

Notes: Designed for severe environment applications with high levels of shock and vibration, small space envelope and restricted cooling. Optional Environment Stress Screening (ESS).

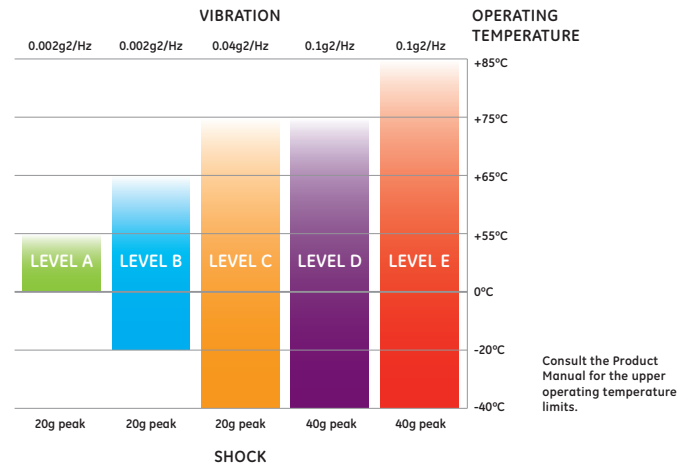
Ruggedization Level 5 Rugged (Conduction-cooled)	
Operating Temperature	-40 to +85°C at the thermal interface
Storage Temperature	-50 to +100°C
Vibration	Random, 0.1g ² /Hz from 15 to 2000Hz per MIL-STD-810E Fig 514.4 - 8 for high performance aircraft. ~12g RMS
Shock	40g peak saw tooth, 11mS duration
Humidity	Up to 95% RH with varying temperature, 10 cycles, 240 hours

Notes: Designed for severe environment applications with high levels of shock and vibration, small space envelope and restricted cooling. Optional Environment Stress Screening (ESS).

Ruggedization Levels A to E

GE Intelligent Platforms has also introduced Ruggedization Levels A to E which are identical in every respect to Ruggedization Levels 1 to 5 except that the upper operating temperature limits are defined on a product by product basis. This allows GE to offer the very highest performance products without the restrictions of fixed upper temperature limits. For products rated under this scheme the upper temperature limit is defined in the product manual.

- Level A = Level 1 : except Operating Temperature = 0 to X°C (consult manual for X)
- Level B = Level 2 : except Operating Temperature = -20 to X°C (consult manual for X)
- Level C = Level 3 : except Operating Temperature = -40 to X°C (consult manual for X)
- Level D = Level 4 : except Operating Temperature = -40 to X°C (consult manual for X)
- Level E = Level 5 : except Operating Temperature = -40 to X°C (consult manual for X)



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